BYW29F series

GENERAL DESCRIPTION

Glass passivated high efficiency rectifier diodes in full pack, plastic envelopes, featuring low forward voltage drop, ultra-fast recovery times and soft recovery characteristic. They are intended for use in switched mode power supplies and high frequency circuits in general where low conduction and switching losses are essential.

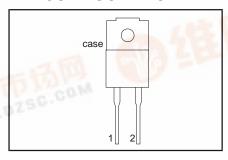
QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	MAX.	MAX.	UNIT
V _{RRM} V _F I _{F(AV)} t _{rr}	BYW29F- Repetitive peak reverse voltage Forward voltage Forward current Reverse recovery time	100 100 0.895 8 25	150 150 0.895 8 25	200 200 0.895 8 25	V V A ns

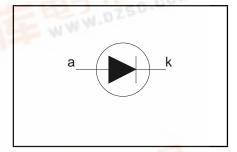
PINNING - SOD100

PIN	DESCRIPTION
1	cathode
2	anode
case	isolated
90	2年 HW

PIN CONFIGURATION



SYMBOL



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

WWW.DZSC

SYMBOL	PARAMETER	CONDITIONS	MIN.	WW	MAX.		UNIT
V _{RRM} V _{RWM} V _R	Repetitive peak reverse voltage Crest working reverse voltage Continuous reverse voltage	COM OF AL		-100 100 100 100	-150 150 150 150	-200 200 200 200	< < < < < < < < < < < < < < < < < < <
I _{F(AV)}	Average forward current ²	square wave; $\delta = 0.5$; $T_{hs} \le 106 ^{\circ}C$	-		8		A
-118	FEF	sinusoidal; a = 1.57; $T_{hs} \le 109 ^{\circ}C$	-		7.3		А
I _{F(RMS)}	RMS forward current	110	-		11.3		Α
I _{FRM}	Repetitive peak forward current	$t = 25 \mu s; \delta = 0.5;$ $T_{hs} \le 109 ^{\circ}C$	-	da-	16		Α
I _{FSM}	Non-repetitive peak forward current	t = 10 ms t = 8.3 ms sinusoidal; with reapplied	12	MAIL	80 88		A A
I ² t T _{stg} T _j	l ² t for fusing Storage temperature Operating junction temperature	V _{RWM(max)} t = 10 ms	- -40 -		32 150 150		A ² s °C °C

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ISOLATION

T_{hs} = 25 °C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _{isol}	Repetitive peak voltage from both terminals to external heatsink	R.H. ≤ 65% ; clean and dustfree	-	-	1500	V
C _{isol}	Capacitance from cathode to external heatsink	f = 1 MHz	-	12	-	pF

THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
R _{th j-hs}	mounting base	with heatsink compound without heatsink compound in free air	1 1 1	- - 55	5.5 7.2 -	K/W K/W K/W
ui j-a	ambient					

STATIC CHARACTERISTICS

T_i = 25 °C unless otherwise stated

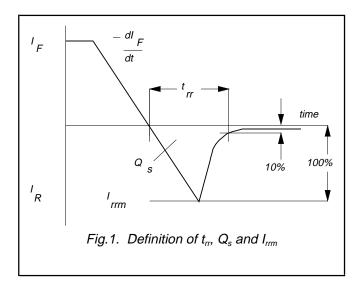
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _F	Forward voltage	I _F = 8 A; T _i = 150°C	-	0.80	0.895	V
	_	$I_F = 8 \text{ A}$	-	0.92	1.05	V
		$I_{\rm F} = 20 \text{ A}$	-	1.1	1.3	V
I _R	Reverse current	$\dot{V}_R = V_{RWM}$; $T_i = 100 ^{\circ}C$	-	0.3	0.6	mΑ
		$V_R = V_{RWM}$	-	2	10	μΑ

DYNAMIC CHARACTERISTICS

 $T_i = 25$ °C unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Q _s	Reverse recovery charge	$I_F = 2 \text{ A}; V_R \ge 30 \text{ V}; -dI_F/dt = 20 \text{ A}/\mu\text{s}$	-	4	11	nC
t _{rr}	Reverse recovery time	$I_F = 1 \text{ A}; V_R \ge 30 \text{ V};$	-	20	25	ns
1.		$-dI_{F}/dt = 100 \text{ A/}\mu\text{s}$			_	١.
I _{rrm}	Peak reverse recovery current	$I_F = 10 \text{ A}; V_R \ge 30 \text{ V}; T_j = 100 \text{ °C};$	-	1	2	A
V_{fr}	Forward recovery voltage	-dl _F /dt = 50 A/μs l _F = 1 A; dl _F /dt = 10 A/μs	-	1	-	V

BYW29F series



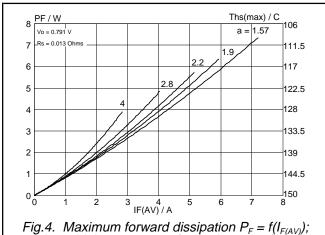
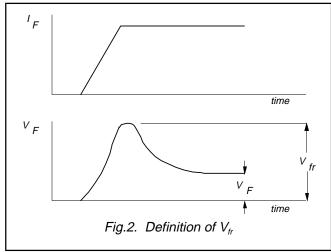
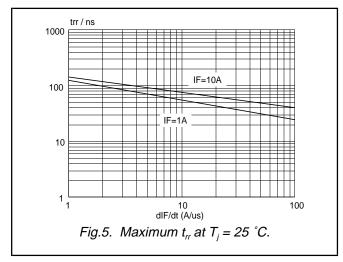


Fig.4. Maximum forward dissipation $P_F = f(I_{F(AV)})$; sinusoidal current waveform where a = form factor $= I_{F(RMS)} / I_{F(AV)}$.





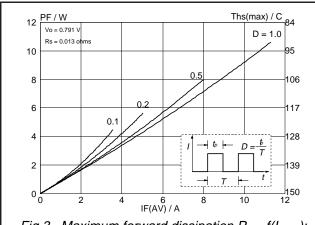
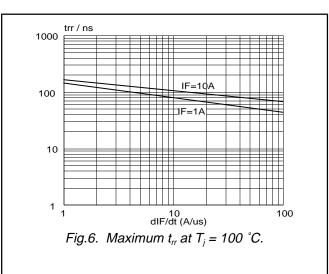
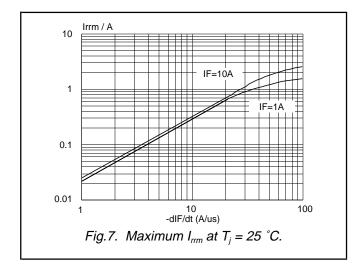
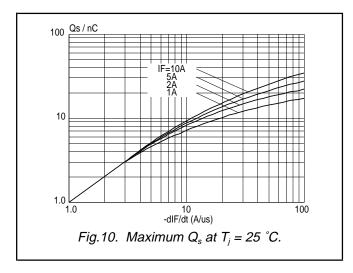


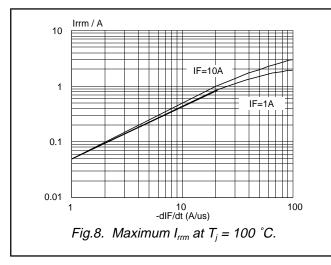
Fig.3. Maximum forward dissipation $P_F = f(I_{F(AV)})$; square current waveform where $I_{F(AV)} = I_{F(RMS)} \times \sqrt{D}$.

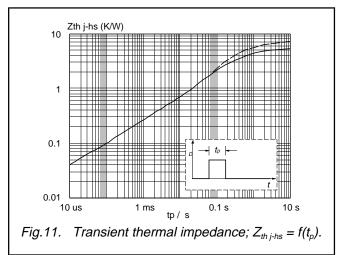


BYW29F series









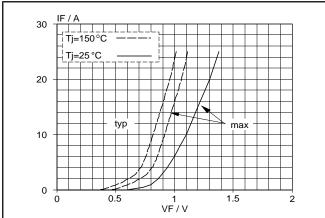
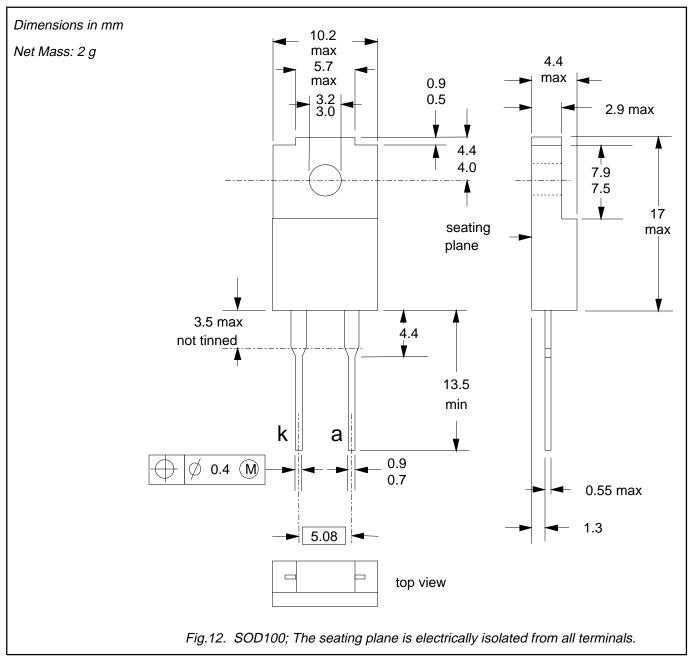


Fig.9. Typical and maximum forward characteristic $I_F = f(V_F)$; parameter T_j

BYW29F series

MECHANICAL DATA



Notes

- Accessories supplied on request: refer to mounting instructions for F-pack envelopes.
 Epoxy meets UL94 V0 at 1/8".

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DEFINITIONS

Data sheet status					
This data sheet contains target or goal specifications for product development.					
This data sheet contains preliminary data; supplementary data may be published later.					
This data sheet contains final product specifications.					

Limiting values

Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information

Where application information is given, it is advisory and does not form part of the specification.

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